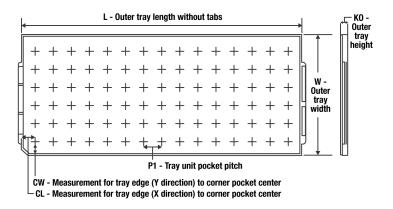


Carrier Material Report for TMS320F2808GBAS

Tray Information:



Device	Package	Package	Pins	SPQ	Unit	Max	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW
	Drawing	Type			Array	Temp						(mm)
					Matrix	(°C)						
TMS32	GBA	NFBGA	100	184	8 x 23	150	315	135.9	7620	13.4	10.1	19.65
0F280												
8GBAS												

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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